TOSHIBA BIPOLAR LINEAR INTEGRATED CIRCUIT SILICON MONOLITHIC

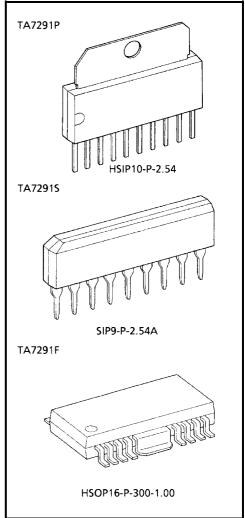
TA7291P,TA7291S,TA7291F

BRIDGE DRIVER

The TA7291P / S / F are Bridge Driver with output voltage control.

FEATURES

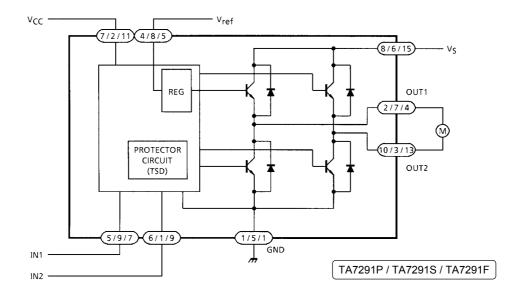
- 4 modes available (CW / CCW / STOP / BRAKE)
- Output current: P type 1.0 A (AVE.) 2.0 A (PEAK) S / F type 0.4 A (AVE.) 1.2 A (PEAK)
- Wide range of operating voltage: VCC (opr.) = 4.5~20 V VS (opr.) = 0~20 V Vref (opr.) = 0~20 V
- Build in thermal shutdown, over current protector and punch = through current restriction circuit.
- Stand-by mode available (STOP MODE)
- Hysteresis for all inputs.



Weight

HSIP10-P-2.54 : 2.47 g (Typ.) SIP9-P-2.54A : 0.92 g (Typ.) HSOP16-P-300-1.00 : 0.50 g (Typ.)

BLOCK DIAGRAM



PIN FUNCTION

| PIN No. | | | 0)/440.01 | ELIZATION DECORPTION | | |
|---------|---|----|------------------|--|--|--|
| Р | S | F | SYMBOL | FUNCTION DESCRIPTION | | |
| 7 | 2 | 11 | V _{CC} | Supply voltage terminal for Logic | | |
| 8 | 6 | 15 | Vs | Supply voltage terminal for Motor driver | | |
| 4 | 8 | 5 | V _{ref} | Supply voltage terminal for control | | |
| 1 | 5 | 1 | GND | GND terminal | | |
| 5 | 9 | 7 | IN1 | Input terminal | | |
| 6 | 1 | 9 | IN2 | Input terminal | | |
| 2 | 7 | 4 | OUT1 | Output terminal | | |
| 10 | 3 | 13 | OUT2 | Output terminal | | |

2

P Type: Pin (3), (9): NC S Type: PIN (4): NC

F Type: PIN (2), (3), (6), (8), (10), (12), (14), and (16): NC For F Type, We recommend FIN to be connected to the GND.

FUNCTION

| INF | PUT | OUT | MODE | |
|-----|-----|------|------|----------|
| IN1 | IN2 | OUT1 | OUT2 | MODE |
| 0 | 0 | 8 | ∞ | STOP |
| 1 | 0 | Н | L | CW / CCW |
| 0 | 1 | L | Н | CCW / CW |
| 1 | 1 | L | L | BRAKE |

∞: High impedance

Note: Inputs are all high active type

MAXIMUM RATINGS (Ta = 25°C)

| CHARACTERISTIC | | | SYMBOL | RATING | UNIT | |
|-----------------------|--------|------------------|------------------|---------------|------|--|
| Supply Voltage | | | V _{CC} | 25 | V | |
| Motor Drive Voltage | | | VS | 25 | V | |
| Reference Voltage | | | V _{ref} | 25 | V | |
| Output Current | PEAK | Р Туре | 1 | 2.0 | А | |
| | | S / F Type | lo (PEAK) | 1.2 | | |
| | AVE. | Р Туре | la | 1.0 | | |
| | | S / F Type | IO (AVE.) | 0.4 | | |
| | P Type | | | 12.5 (Note 1) | | |
| Power Dissipation | | S Type | P_{D} | 0.95 (Note 2) | W | |
| | | F Type | | 1.4 (Note 3) | | |
| Operating Temperature | | | T _{opr} | -30~75 | °C | |
| Storage Temperature | | T _{stg} | -55~150 | °C | | |

Note 1: Tc = 25°C (TA7291P)

Note 2: No heat sink

Note 3: PCB ($60 \times 30 \times 1.6$ mm, occupied copper area in excess of 50%) Mounting Condition.

3

Wide range of operating voltage: $V_{CC (opr.)} = 4.5 \sim 20 \text{ V}$

V_{S (opr.)} = 0~20 V

V_{ref (opr.)} = 0~20 V

V_{ref} ≤ V_S

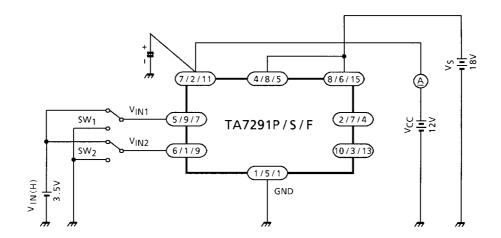
ELECTRICAL CHARACTERISTICS

(Unless otherwise specified, Ta = 25°C, V_{CC} = 12 V, V_{S} = 18 V)

| CHARACTERISTIC | | | SYMBOL | TEST CIR- CUIT | TEST CONDITION | MIN | TYP. | MAX | UNIT | |
|--|-------------------------|------------------|------------------------|--------------------------------------|--|---------|------|------|------|--|
| Supply Current | | | I _{CC1} | | Output OFF, CW / CCW mode | 1 | 8.0 | 13.0 | mA | |
| | | | I _{CC2} | 1 | Output OFF, Stop mode | - | 0 | 50 | μΑ | |
| | | I _{CC3} | | Output OFF, Brake mode | 1 | 6.5 | 10.0 | mA | | |
| Input Operating Voltage 1 (High) 2 (Low) | | V _{IN1} | | T _i = 25°C | 3.5 | _ | 5.5 | ٧ | | |
| | | V _{IN2} | 2 | 1]-25 0 | GND | _ | 0.8 | | | |
| Input Current | | I _{IN} |] _ | V _{IN} = 3.5 V, Sink mode | _ | 3 | 10 | μΑ | | |
| Input Hysteresis | nput Hysteresis Voltage | | ΔV_{T} | | _ | _ 0.7 _ | | V | | |
| Saturation Voltage | P/S/F | Upper Side | V _{SAT U-1} | | V _{ref} = V _S , V _{OUT} - V _S measure I _O = 0.2 A, CW / CCW mode | _ | 0.9 | 1.2 | V | |
| | Type | Lower Side | V _{SAT L-1} | 3 | V _{ref} = V _S , V _{OUT} - GND measure I _O = 0.2 A, CW / CCW mode | _ | 0.8 | 1.2 | | |
| | S/E | Upper Side | V _{SAT U-2} | | $V_{ref} = V_S$, $V_{OUT} - V_S$ measure $I_O = 0.4$ A, CW / CCW mode | _ | 1.0 | 1.35 | | |
| | S / F Type | Lower Side | VSAT L-2 | | V _{ref} = V _S , V _{OUT} - GND measure I _O = 0.4 A, CW / CCW mode | _ | 0.9 | 1.35 | | |
| | | Upper Side | V _{SAT U-3} | | V _{ref} = V _S , V _{OUT} - V _S measure I _O = 1.0 A, CW / CCW mode | _ | 1.3 | 1.8 | | |
| | P Type | Lower Side | VSAT L-3 | | V _{ref} = V _S , V _{OUT} - GND measure I _O = 1.0 A, CW / CCW mode | _ | 1.2 | 1.85 | | |
| Output Voltage (Upper Side) | S / F Type | | V _{SAT U-1} | - 3 | V _{ref} = 10 V V _{OUT} - GND measure, I _O = 0.2 A, CW / CCW mode | _ | 11.2 | _ | V | |
| | | | V _{SAT U-2} , | | V _{ref} = 10 V V _{OUT} - GND measure, I _O = 0.4 A, CW / CCW mode | 10.4 | 10.9 | 12.2 | | |
| | Р Туре | | V _{SAT U-3} , | | V _{ref} = 10 V V _{OUT} - GND measure, I _O = 0.5 A, CW / CCW mode | ı | 11.0 | _ | | |
| | | | V _{SAT U-4} , | | V _{ref} = 10 V V _{OUT} - GND measure, I _O = 1.0 A, CW / CCW mode | 10.2 | 10.7 | 12.0 | | |
| Leakage Current Lower Side | | | I _{L U} | 4 | V _L = 25 V | _ | _ | 50 | | |
| | | | ILL | - | V _L = 25 V | _ | _ | 50 | μΑ | |
| Diode Forward Voltage | S / F Type | Upper Side | V _{F U−1} | | I _F = 0.4 A | _ | 1.5 | _ | | |
| | Р Туре | Lower Side | V _{F U-2} | _ | I _F = 1 A | _ | 2.5 | _ | | |
| | S / F Type | Upper Side | V _{F L−1} | 5 | I _F = 0.4 A | _ | 0.9 | _ | V | |
| | Р Туре | Lower Side | V _{F L-2} | | I _F = 1 A | _ | 1.2 | _ | | |
| Reference Current | | I _{ref} | 2 | V _{ref} = 10 V, Source mode | _ | 20 | 40 | μΑ | | |

TEST CIRCUIT 1

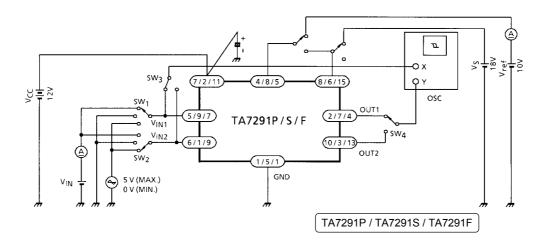
Icc1, Icc2, Icc3



Note: HEAT FIN of TA7291F is connected to GND.

TEST CIRCUIT 2

 $V_{IN~1}, V_{IN~2}, I_{IN~,} \Delta V_{T}, I_{ref}$

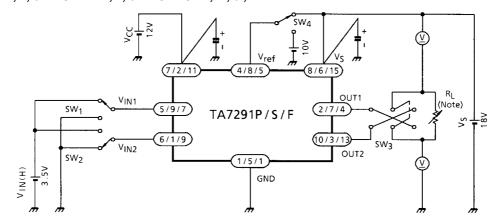


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Note: HEAT FIN of TA7291F is connected to GND.

TEST CIRCUIT 3

VSAT U-1, 2, 3 VSAT L-1, 2, 3 VSAT U-1', 2', 3', 4'



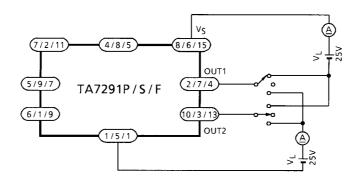
Note: IOUT calibration is required to adjust specified values of test conditions by RL.

 $(I_{OUT} = 0.2 \text{ A} / 0.4 \text{ A} / 0.5 \text{ A} / 1.0 \text{ A})$

Note: HEAT FIN of TA7291F is connected to GND.

TEST CIRCUIT 4

IL U, L

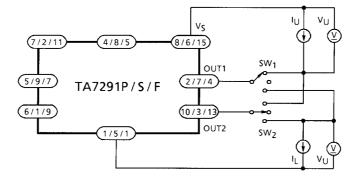


TA7291P / TA7291S / TA7291F

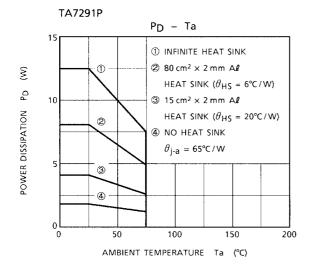
Note: HEAT FIN of TA7291F is connected to GND.

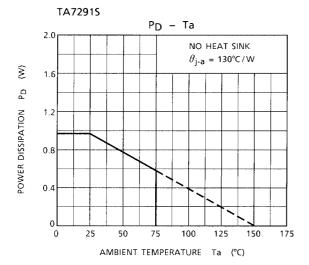
TEST CIRCUIT 5

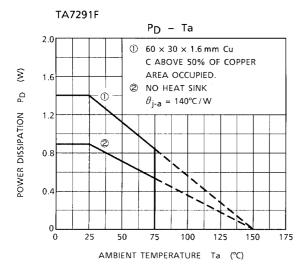
 $V_{F U-1, 2} V_{F L-1, 2}$

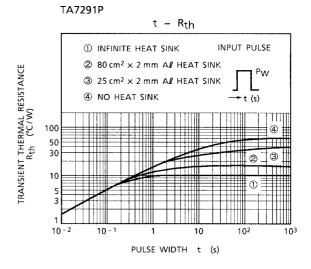


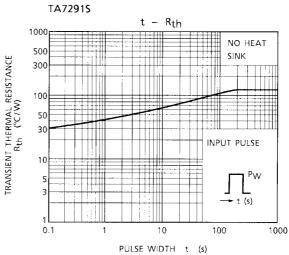
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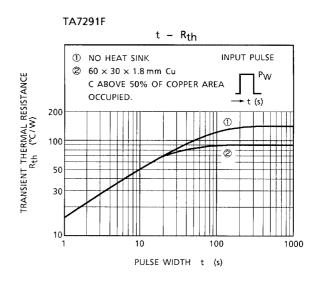


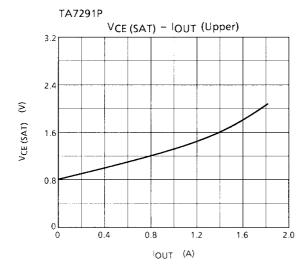


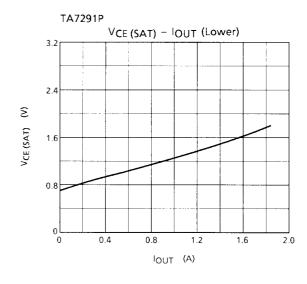


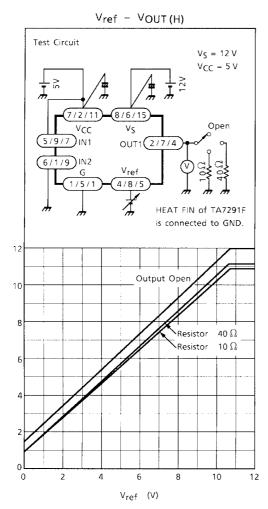






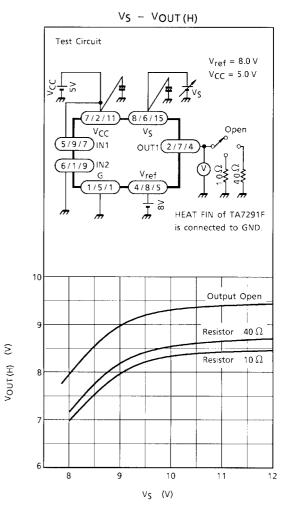






3

Vout (H)

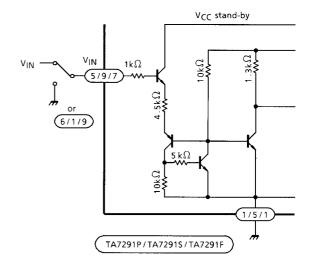


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NOTES

Input circuit

Input Terminals of pin (5) and (6) (TA7291P) are all high active type and have a hysteresis of 0.7 V (typ.), 3 μ A (typ.) of source mode input current is required.



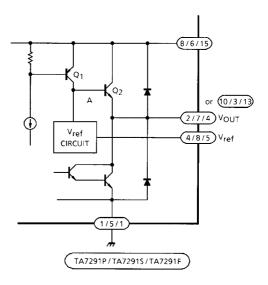
Output circuit

Output voltage is controlled by $V_{\rm ref}$ voltage. Relationship between $V_{\rm OUT}$ and $V_{\rm ref}$ is

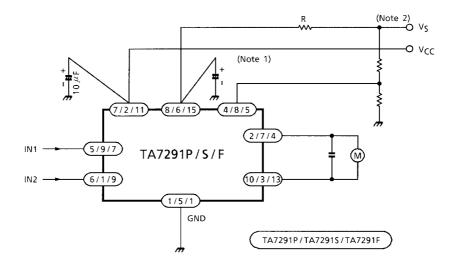
 $V_{OUT} = V_{BE} (\approx 0.7) + V_{ref}$

 V_{ref} terminal required to connect to V_{S} terminal for stable operation in case of no requirement of V_{OUT} control.

 $V_{ref} \le V_{S}$



APPLICATION CIRCUIT



Note 1: Experiment to find the optimum capacitor valve.

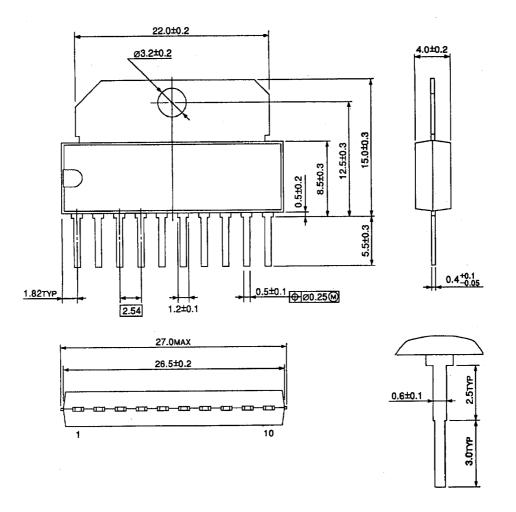
Note 2: To protect against excess current, current limitation resistor R should be inserted where necessary.

NOTES

- Be careful when switching the input because rush current may occur.
 When switching, stop mode should be entered or current limitation resister R should be inserted.
- The IC functions cannot be guaranteed when turning power on of off. Before using the IC for application, check that there are no problems.
- Utmost care is necessary in the design of the output line, Vs, Vcc and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

PACKAGE DIMENSIONS

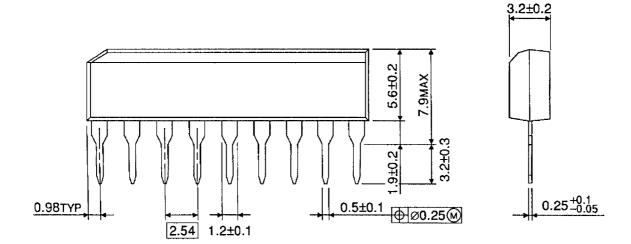
HSIP10-P-2.54 Unit: mm

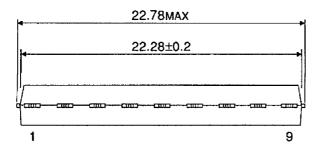


Weight: 2.47 g (Typ.)

PACKAGE DIMENSIONS

SIP9-P-2.54A Unit: mm

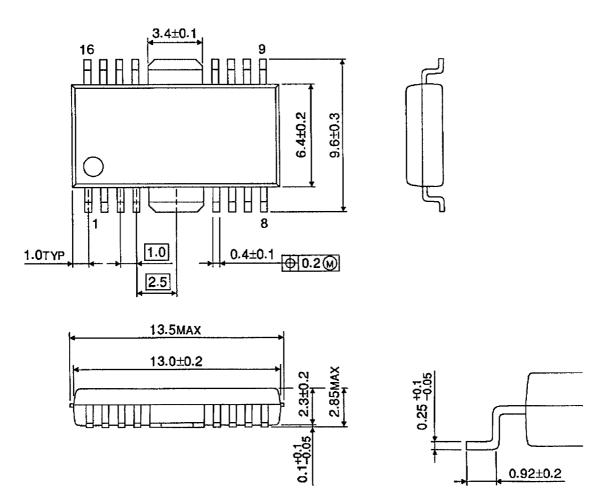




Weight: 0.92 g (Typ.)

PACKAGE DIMENSIONS

HSOP16-P-300-1.00 Unit: mm



Weight: 0.50 g (Typ.)

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